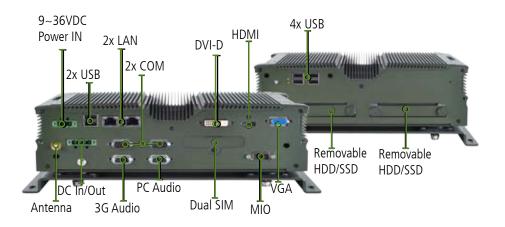
### LVC-5570

## Fanless In-Vehicle Computer with Intel Core i7-2655LE Processor



#### **Features**

# Fanless Design with Corrugated Aluminum

The corrugated aluminum casing allow heat to dissipate off the top of the platform allowing for a fanless design.

## Design for MIL-STD-810G with Extreme Vibration Resistance

LVC-5570 is in compliance with MIL-STD-810G in vibration and shock with SSD storage. The Suspension Kit is also available for further harsh environment.

#### Vehicle Ignition Power Management

Detect the ignition on/off status and allow controlling delay time by flexible setting via utility.

# **Design for Extreme Operating temperature**

This product is ruggedized to support a wider than usual range of temperatures. Outfitted with industrial components (SSD, Memory) this appliance can thrive in harsh conditions.

#### Diversity of Digital Input/ Output Support

Besides 4x DI, 3x DO with 12V TTL level for easy usage with vehicle parts., additionally LVC-5570 supports 2x DI (5V TTL for MCU) which can connect sensors to detect the environment. Once certain events occur, LVC-5570 can be turned on automatically.

#### **3G Voice Communication**

This vehicle PC supports 3G voice communication which allows people can communicate with operating center through voice directly. (Validated MC-8090/8092 3G module Only)

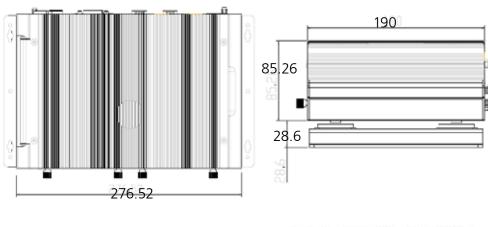
#### **Convenient DC Output**

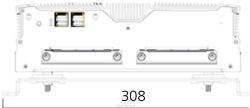
LVC-5570 offer 9~36VDC (max 10A) output for external devices. It can be enabled or disabled via software.

### **Dual Front Access SIM Card Reader**

The external SIM card readers, allowing end-users to change or install a SIM card without opening the case.

#### Dimensions: 276.52 x 190 x 85.26mm







### **Specifications**

Dimensions (WxHxD)		276.52x190x 85.26mm
Processor		Intel Core i7-2655LE Processors
Chipset		Intel HM65
System Technology		DDR3 SO-DIMM x2
Memory	Max. Capacity	
Storage	SATA	Removable 2.5" SSD/HDD drive bay x2, on-board 8GB SSD
Ethernet Controller		Intel 82574L x2
Graphic Controller		Intel integrated HD graphic engine
Audio Controller		Realtek ALC886 HD codec
IO	LAN	GbE RJ45 x2
	Display	DVI-D, maximum resolution up to 1920 x 1200 @60 Hz
		VGA, maximum resolution up to 2048 x 1536 @75 Hz
		HDMI, maximum resolution up to 1920 x 1200 @60 Hz
		Dual display function supports Independent, clone and extended
		mode.(VGA+DVI or VGA+HDMI)
	Audio	1x Mic-in and Line-out (for PC) with 2 watt
		1x Mic-in and Line-out (for Validated MC-8090/8092 3G module)
		under DB9 female connector
	Serial I/O	2x RS-232/422/485 with RI/5V/12V
	GPS	Ublox NEO-6Q GPS receiver module
	G-sensor	ADXL 345
	G-Selisol	4x DI 12V TTL Level
	GPIO	
		3x DO 12V TTL Level
	USB 2.0	2x DI (for MCU) 5V TTL Level
	Power Input	Type A x6 3-pin terminal block (+, -, ignition)
	Expansion	Mini-PClex4 with 3 SIM card readers
	Expansion	IVIIIII-F CIEX4 WILIT 3 31W Cald readel3
	Others	External: 5x SMA antenna hole, reset, Remote Power switch
		9~36Vdc (max. 10A) output software On/Off controlable
Power Input		+9~36VDC input range, ATX mode support ignition delay on/off
		control
AC Adapter		Ordering Option
OS Support		Linux: Redhad Enterprise 5/ Fedora 14. Linux Kernel 2.6.18 or
		later
		Windows: Microsoft Windows 7/XP/XP pro; Embedded/7 Embed-
		ded
Certifications		CE, FCC Class A, E13, RoHS
Compliance		Vibration: MIL-STD-810G, Method 514.6
		Shock:MIL-STD-810G, Method 516.6
0	E	With Industrial Components
Operating Temperature Range	Extended	-20~55°C/-4~131°F
	Charada, I	With Commercial Components
	Standard	-5~45°C / 23~113°F

### **Ordering Information**

Intel® i7-2655LE In-Vehicle Computer, DDR3 SO-DIMM x2,
Onboard 8GB SSD chip, 2.5" Removable Drive Bay x2, Mini-PCle
x4 with three SIM card reader, Intel GbE x2, USB x6, COM x2, PC
Audio, Multiple I/O integrated Dlx4, DOx3, remote power button
and 12VDC output, DC Power input +9~36Vdc with Ignition,
Suspending Kit and PoE Power Adapter included.

connect@lannerinc.com www.lannerinc.com 8